

NOT RECOMMENDED FOR NEW DESIGN **CONTACT US**



DMJ70H600SH3

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON) Max	I _D T _C = +25°C
700V	0.6Ω @ $V_{GS} = 10V$	11A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor controls
- Backlighting
- AC-DC converters

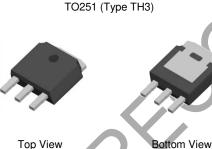
Features and Benefits

- Low On-Resistance
- High BVDSS Rating for Power Application
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

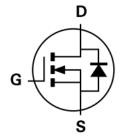
- Package: TO251
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)



Top View



Top View Pin Configuration



Internal Schematic

Ordering Information (Note 4)

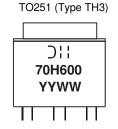
Part Number	Package	Packing		
Part Nulliber	Package	Qty.	Carrier	
DMJ70H600SH3	TO251 (Type TH3)	75 Pieces	Tube	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and < 1000ppm antimony compounds.</p>

 4) For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



70H600 = Product Type Marking Code YYWW = Date Code Marking YY or YY = Last Two Digits of Year (ex: 22 = 2022) WW or WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	700	V
Gate-Source Voltage		V _{GSS}	±30	V
Continuous Drain Current (Note 5) V _{GS} = 10V	$T_C = +25$ °C $T_C = +100$ °C	I _D	11 7	Α
Maximum Body Diode Forward Current (Note 6)		Is	1.8	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	11	Α
Avalanche Current (Note 7)	L = 60mH	I _{AS}	1.5	Α
Avalanche Energy (Note 7)	L = 60mH	Eas	67.5	mJ
Peak Diode Recovery dv/dt (Note 7)		dv/dt	5	V/ns

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_C = +25^{\circ}C$ $T_C = +100^{\circ}C$	PD	113 45	W
Thermal Resistance, Junction to Ambient (Note 6)		R _{0JA}	57	°C/W
Thermal Resistance, Junction to Case (Note 5)		Rejc	1.1	C/VV
Operating and Storage Temperature Range		Т _J , Тsтg	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

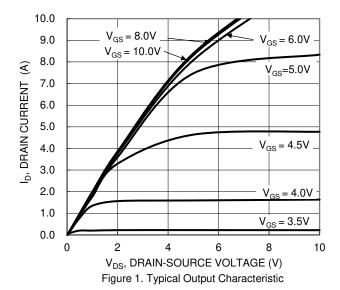
Characteristic	Symbol	Min	Two	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)	Syllibol	IVIIII	Тур	IVIAX	Ollit	rest condition		
· · ·	D14	700			W	N/ 0// 1 050 A		
Drain-Source Breakdown Voltage	BVDSS	700	_ \	<u> </u>	V	$V_{GS} = 0V, I_{D} = 250\mu A$		
Zero Gate Voltage Drain Current	IDSS		_	1	μΑ	$V_{DS} = 700V$, $V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}			100	nA	$V_{GS} = \pm 30V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	Vgs(TH)	2	2.9	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
Static Drain-Source On-Resistance	RDS(ON)	->	0.5	0.6	Ω	$V_{GS} = 10V, I_D = 2.4A$		
Diode Forward Voltage	Vsp	/	0.9	1.2	V	V _{GS} = 0V, I _S = 4.6A		
DYNAMIC CHARACTERISTICS (Note 7)	DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	_	643	_		V _{DS} = 25V, f = 1MHz, V _{GS} = 0V		
Output Capacitance	Coss	_	524	_	pF			
Reverse Transfer Capacitance	Crss	_	13.5	_				
Gate Resistance	Rg	_	3.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge	Qg	_	18.2	_		$V_{DD} = 380V, I_D = 4.6A,$ $V_{GS} = 10V$		
Gate-Source Charge	Qgs	_	2.5	_	nC			
Gate-Drain Charge	Qgd	_	8.5	_				
Turn-On Delay Time	tD(ON)	_	11	_		$V_{DD} = 380V, V_{GS} = 10V,$ $R_g = 25\Omega, I_D = 4.6A$		
Turn-On Rise Time	t _R	_	22	_	ns			
Turn-Off Delay Time	t _{D(OFF)}	_	85	_	115			
Turn-Off Fall Time	tF	_	23	_				
Body Diode Reverse Recovery Time	trr	_	193	_	ns	la 44 dl/dt 1004/up		
Body Diode Reverse Recovery Charge	Q _{RR}	_	1.6	_	μC	$I_S = 4A$, $dI/dt = 100A/\mu s$		

Notes:

- 5. Device mounted on infinite heatsink.
- S. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Guaranteed by design. Not subject to production testing.
 Short duration pulse test used to minimize self-heating effect.







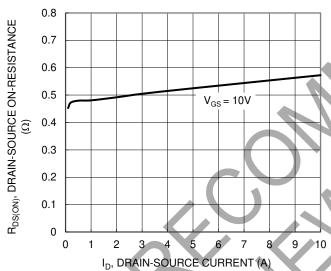


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

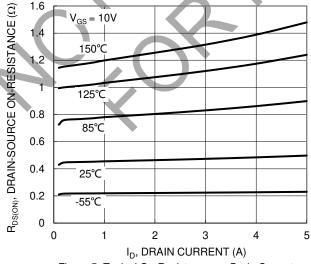
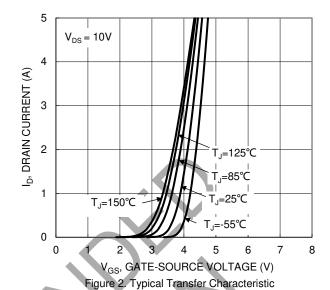
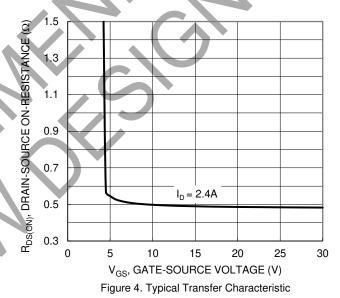


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





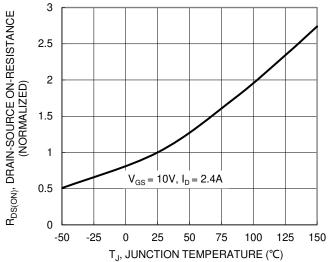


Figure 6. On-Resistance Variation with Temperature





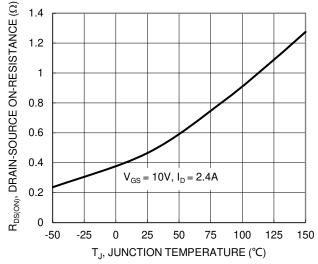


Figure 7. On-Resistance Variation with Temperature

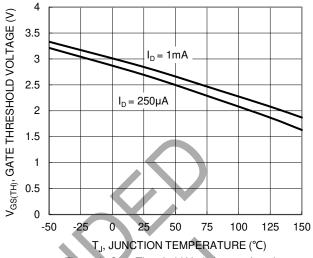
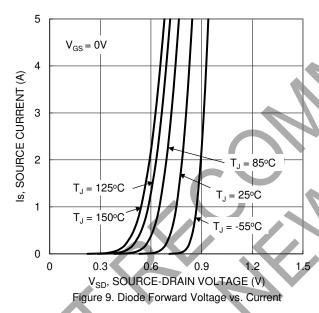


Figure 8. Gate Threshold Variation vs. Junction Temperature



 C_T , JUNCTION CAPACITANCE ($\mathsf{p}\mathsf{F}$) 100 10 1

 C_{iss}

V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 11. Typical Junction Capacitance

80 100 120 140 160 180 200

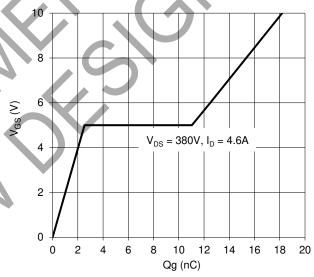


Figure 10. Gate Charge

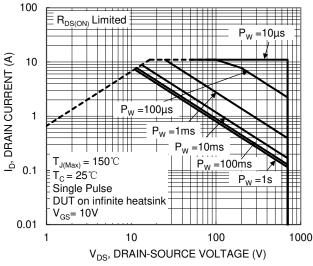


Figure 12. SOA, Safe Operation Area

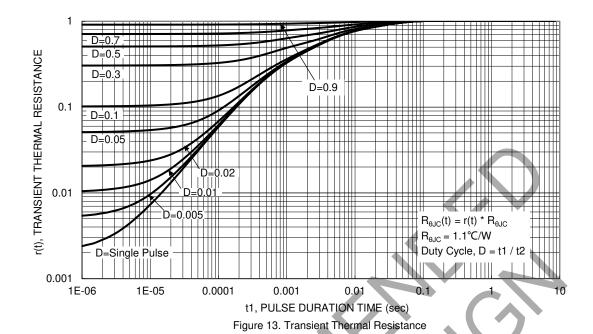
0 0 20

10000

1000

f=1MHz



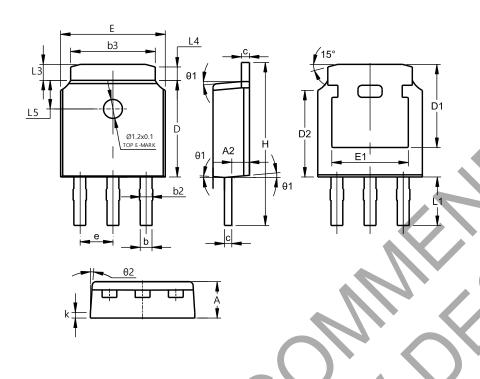




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO251 (Type TH3)



TO251 (Type TH3)						
Dim	Min	Max	Тур			
A	2.20	2.40	2.30			
A2	0.97	1.17	1.07			
b	0.68	0.90	0.78			
b2	0.76	0.95	0.84			
b 3	5.20	5.50	5.33			
С	0.43	0.63	0.53			
D	5.98	6.10				
D1	5.30 REF					
D2	5.26	5.66	5.46			
e	2.	286 BS	C			
E	6.40	6.80	6.60			
E 1	4.63	5.03	4.83			
H	9.40	9.85	9.62			
k).40REI	<u> </u>			
	2.30	2.70	2.50			
L3	0.88 1.28		1.02			
L4	0.75 REF					
L5	1.65	1.95	1.80			
θ1	5°	9°	7°			
θ2	5°	9°	7°			
All Dimensions in mm						



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